

DATA SHEET

For a complete data sheet, please also download:

- The IC04 LOC莫斯 HE4000B Logic Family Specifications HEF, HEC
- The IC04 LOC莫斯 HE4000B Logic Package Outlines/Information HEF, HEC

HEF4081B **gates** Quadruple 2-input AND gate

Product specification
File under Integrated Circuits, IC04

January 1995

Quadruple 2-input AND gate**HEF4081B
gates****DESCRIPTION**

The HEF4081B provides the positive quadruple 2-input AND function. The outputs are fully buffered for highest noise immunity and pattern insensitivity of output impedance.

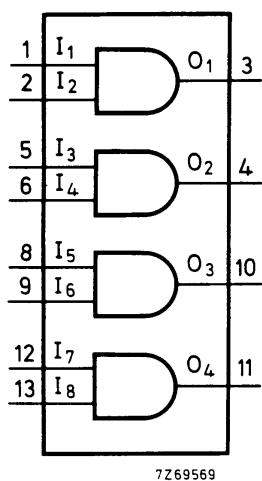


Fig.1 Functional diagram.

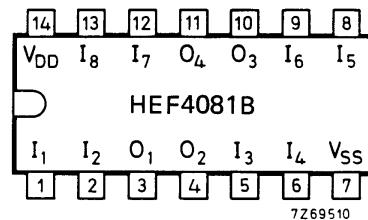


Fig.2 Pinning diagram.

HEF4081BP(N): 14-lead DIL; plastic
(SOT27-1)

HEF4081BD(F): 14-lead DIL; ceramic (cerdip)
(SOT73)

HEF4081BT(D): 14-lead SO; plastic
(SOT108-1)

(): Package Designator North America

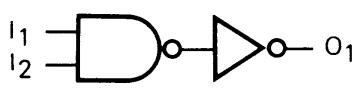


Fig.3 Logic diagram (one gate).

FAMILY DATA, I_{DD} LIMITS category GATES

See Family Specifications

Quadruple 2-input AND gate

HEF4081B
gates**AC CHARACTERISTICS** $V_{SS} = 0 \text{ V}$; $T_{amb} = 25^\circ\text{C}$; $C_L = 50 \text{ pF}$; input transition times $\leq 20 \text{ ns}$

	V_{DD} V	SYMBOL	TYP.	MAX.	TYPICAL EXTRAPOLATION FORMULA
Propagation delays $I_h \rightarrow O_n$ HIGH to LOW	5	t_{PHL}	55	110 ns	$28 \text{ ns} + (0,55 \text{ ns/pF}) C_L$
	10		25	50 ns	$14 \text{ ns} + (0,23 \text{ ns/pF}) C_L$
	15		20	40 ns	$12 \text{ ns} + (0,16 \text{ ns/pF}) C_L$
	LOW to HIGH	t_{PLH}	45	90 ns	$18 \text{ ns} + (0,55 \text{ ns/pF}) C_L$
			20	40 ns	$9 \text{ ns} + (0,23 \text{ ns/pF}) C_L$
			15	30 ns	$7 \text{ ns} + (0,16 \text{ ns/pF}) C_L$
Output transition times HIGH to LOW	5	t_{THL}	60	120 ns	$10 \text{ ns} + (1,0 \text{ ns/pF}) C_L$
	10		30	60 ns	$9 \text{ ns} + (0,42 \text{ ns/pF}) C_L$
	15		20	40 ns	$6 \text{ ns} + (0,28 \text{ ns/pF}) C_L$
	LOW to HIGH	t_{TLH}	60	120 ns	$10 \text{ ns} + (1,0 \text{ ns/pF}) C_L$
			30	60 ns	$9 \text{ ns} + (0,42 \text{ ns/pF}) C_L$
			20	40 ns	$6 \text{ ns} + (0,28 \text{ ns/pF}) C_L$

	V_{DD} V	TYPICAL FORMULA FOR P (μW)	
Dynamic power dissipation per package (P)	5 10 15	$450 f_i + \sum (f_o CL) \times V_{DD}^2$ $2\ 900 f_i + \sum (f_o CL) \times V_{DD}^2$ $11\ 700 f_i + \sum (f_o CL) \times V_{DD}^2$	where f_i = input freq. (MHz) f_o = output freq. (MHz) C_L = load capacitance (pF) $\sum (f_o C_L)$ = sum of outputs V_{DD} = supply voltage (V)

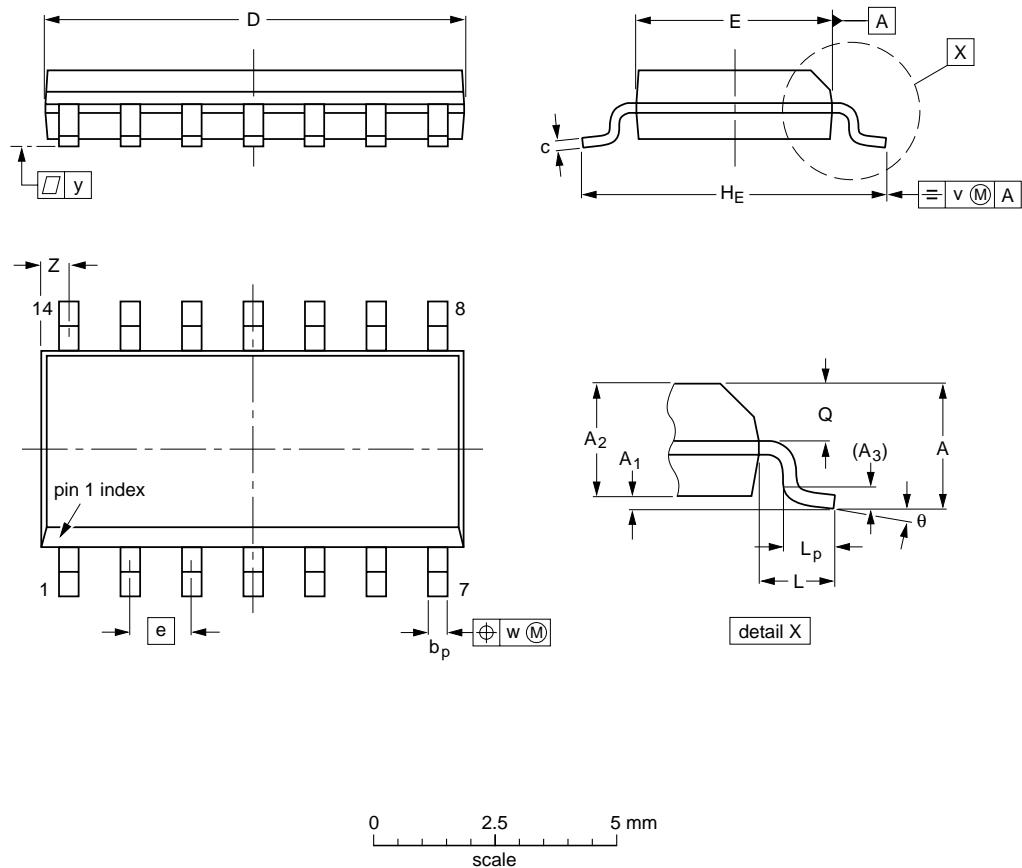
Package information

Package outlines

SO

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	1.75 0.10	0.25 1.45	0.25 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069 0.004	0.010 0.049	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT108-1	076E06S	MS-012AB				95-01-23 97-05-22

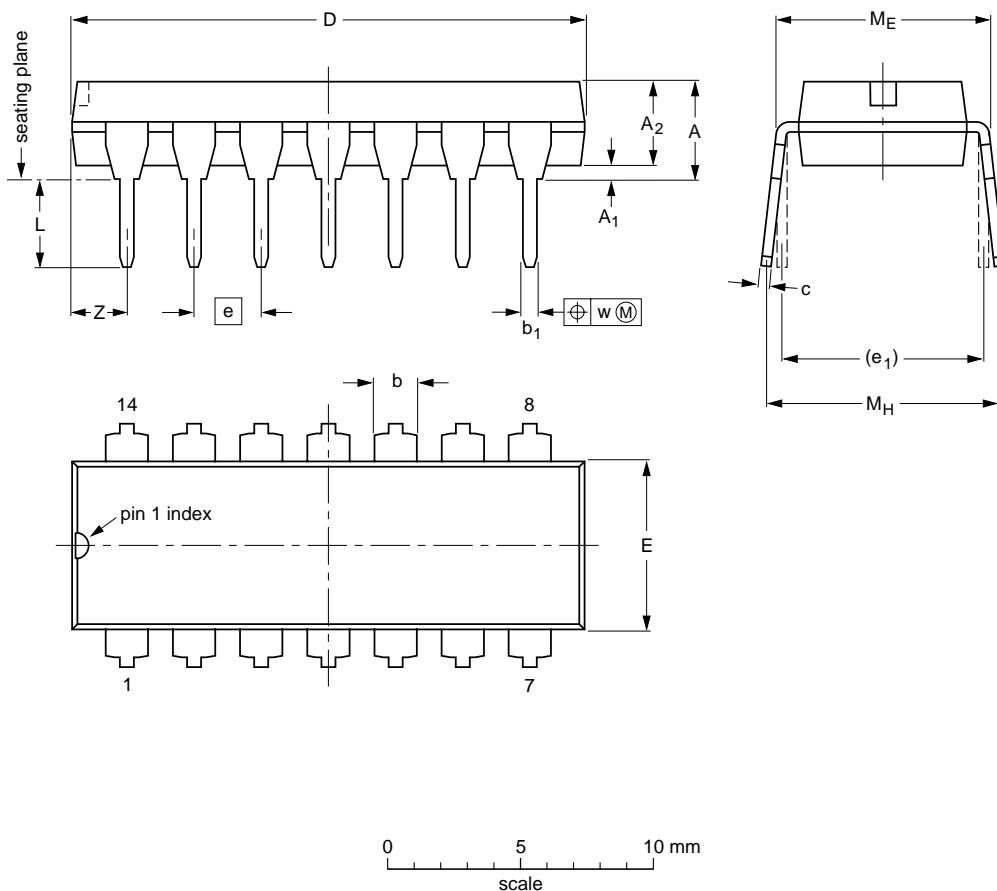
Package information

Package outlines

DIP

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

- Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11